Pixus Offers Hard-To-Find Rails and Other Subrack Components

Waterloo, Ontario — Feb 22, 2017   – Pixus Technologies, a provider of embedded computing and enclosure solutions, offers specialty extruded rails and other components for electronic enclosure subracks.

The Pixus subrack components include front, rear, and center rails for the modular attachment of card guides or DIN-type connectors in all types of configurations.   The modular rails have mounting holes in equally spaced 0.2" intervals allowing flexibility of board pitches, sizes, etc. They include hard-to-find versions such as Z-rails for DIN-type connector mounting and horizontal center rails for stacked/tiered card plugging in the same subrack. Other components include identification strips, conductive strips, specialty EMC gasketing, and insulating strips.

Pixus offers modular subracks in 19" rackmount and various other widths and heights.   The company also offers full chassis platforms, backplanes, and enclosures for instrumentation.

About Pixus Technologies

Leveraging over 20 years of innovative standard products, the Pixus team is comprised of industry experts in electronics packaging. Founded in 2009 by senior management from Kaparel Corporation, a Rittal company, Pixus Technologies' embedded backplanes and systems are focused primarily on ATCA, OpenVPX, MicroTCA, and custom designs.   Pixus also has an extensive offering of VME-based and cPCI-based solutions.   In May 2011, Pixus Technologies became the sole authorized North and South American supplier of the electronic packaging products previously offered by Kaparel Corporation and Rittal.